



Surface-mount Fuses Fast-Acting Chip Fuses

Fast-acting chip fuses help provide overcurrent protection on systems using DC power sources up to 63V_{DC}. The fuse's monolithic, multilayer design provides the highest hold current in the smallest footprint, reduces diffusion-related aging, improves product reliability and resilience, and enhances high-temperature performance in a wide range of circuit designs.

These RoHS-compliant surface-mount devices offer strong arc suppression characteristics and facilitate the development of more reliable, high performance consumer electronics such as laptops, multimedia devices, cell phones, and other portable electronics.



Benefits

- Small size with high-current ratings
- Excellent temperature stability
- High reliability and resilience
- Strong arc suppression characteristics

Features

- Lead free materials and RoHS compliant
- Halogen free
(refers to: Br≤900ppm, Cl≤900ppm, Br+Cl≤1500ppm)
- Monolithic, multilayer design
- High-temperature performance
- -55°C to +125°C operating temperature range

Applications

- | | | |
|-------------------|------------------------|----------------|
| • Laptops | • Printers | • Game systems |
| • Digital cameras | • DVD players | • LCD monitors |
| • Cell phones | • Portable electronics | • Scanners |

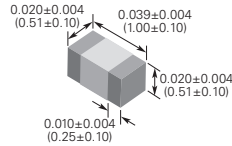
Table FF1 Clear Time Characteristics for Fast-Acting Chip Fuses

% of rated current	Clear time at 25°C
100%	4 hours min.
250%	5 seconds max.
400%	0.05 seconds max.

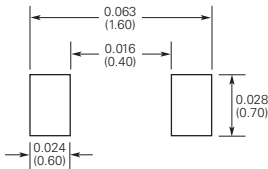
Table FF2 Typical Electrical Characteristics, Dimensions and Recommended Pad Layout for Fast-Acting Chip Fuses

0402 (1005mm) Fast-Acting Chip Fuses

Shape and Dimensions
Inch (mm)



Recommended Pad Layout
Inch (mm)



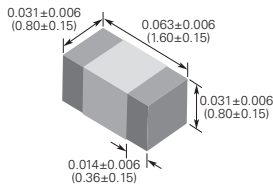
Typical Electrical Characteristics

Max. Interrupt Ratings

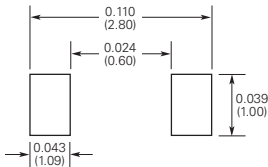
Part Number	Typical Electrical Characteristics			Max. Interrupt Ratings	
	Rated Current (A)	Nominal Cold DCR (Ω)*	Nominal I ² t (A ² sec) [†]	Voltage (V _{DC})	Current (A)
0402SFF050F/24	0.50	0.380	0.0043	24	35
0402SFF075F/24	0.75	0.210	0.0076	24	35
0402SFF100F/24	1.00	0.120	0.0170	24	35
0402SFF150F/24	1.50	0.056	0.0490	24	35
0402SFF200F/24	2.00	0.035	0.0700	24	35
0402SFF300F/24	3.00	0.021	0.1250	24	35
0402SFF400F/24	4.00	0.014	0.2250	24	35

0603 (1608mm) Fast-Acting Chip Fuses

Shape and Dimensions
Inch (mm)



Recommended Pad Layout
Inch (mm)



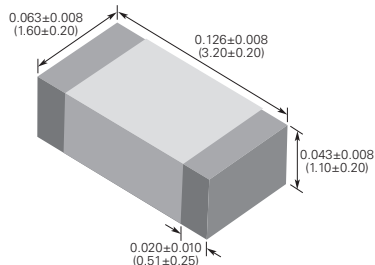
Typical Electrical Characteristics

Max. Interrupt Ratings

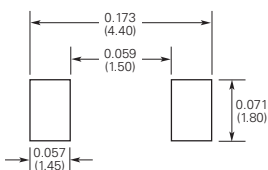
Part Number	Typical Electrical Characteristics			Max. Interrupt Ratings	
	Rated Current (A)	Nominal Cold DCR (Ω)*	Nominal I ² t (A ² sec) [†]	Voltage (V _{DC})	Current (A)
0603SFF050F/32	0.50	0.485	0.0029	32	50
0603SFF075F/32	0.75	0.254	0.0064	32	50
0603SFF100F/32	1.00	0.131	0.0160	32	50
0603SFF150F/32	1.50	0.059	0.0300	32	35
0603SFF200F/32	2.00	0.044	0.0600	32	35
0603SFF250F/32	2.50	0.032	0.1150	32	35
0603SFF300F/32	3.00	0.025	0.1900	32	35
0603SFF350F/32	3.50	0.024	0.2950	32	35
0603SFF400F/32	4.00	0.018	0.4000	32	35
0603SFF500F/32	5.00	0.013	0.7000	32	35
0603SFF600F/24	6.00	0.010	1.1250	24	35

1206 (3216mm) Fast-Acting Chip Fuses

Shape and Dimensions
Inch (mm)



Recommended Pad Layout
Inch (mm)



Typical Electrical Characteristics

Max. Interrupt Ratings

Part Number	Typical Electrical Characteristics			Max. Interrupt Ratings	
	Rated Current (A)	Nominal Cold DCR (Ω)*	Nominal I ² t (A ² sec) [†]	Voltage (V _{DC})	Current (A)
1206SFF050F/63	0.50	0.730	0.0021	63	50
1206SFF075F/63	0.75	0.513	0.0052	63	50
1206SFF100F/63	1.00	0.220	0.0120	63	50
1206SFF150F/63	1.50	0.120	0.0250	63	50
1206SFF175F/63	1.75	0.100	0.0450	63	50
1206SFF200F/63	2.00	0.050	0.0700	63	50
1206SFF250F/32	2.50	0.035	0.1400	32	50
1206SFF300F/32	3.00	0.031	0.2200	32	50
1206SFF400F/32	4.00	0.022	0.3800	32	45
1206SFF500F/32	5.00	0.015	0.6000	32	45
1206SFF600F/32	6.00	0.013	1.0000	32	50
1206SFF700F/32	7.00	0.011	1.7500	32	50
1206SFF800F/32	8.00	0.008	2.5000	32	50
1206SFF600F/24	6.00	0.013	1.0000	24	45
1206SFF700F/24	7.00	0.011	1.7500	24	45
1206SFF800F/24	8.00	0.008	2.5000	24	45

* Measured at ≤10% of rated current and 25°C ambient temperature.

† Melting I²t at 0.001 sec clear time.

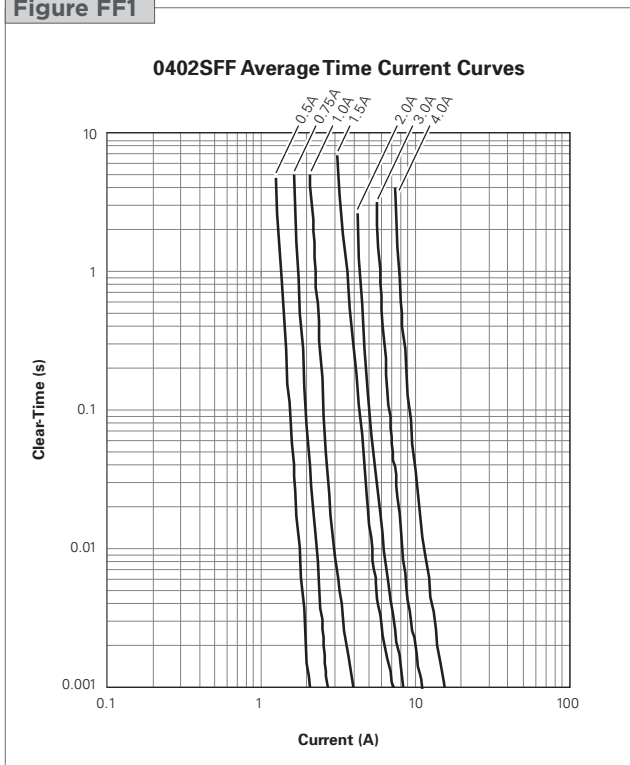
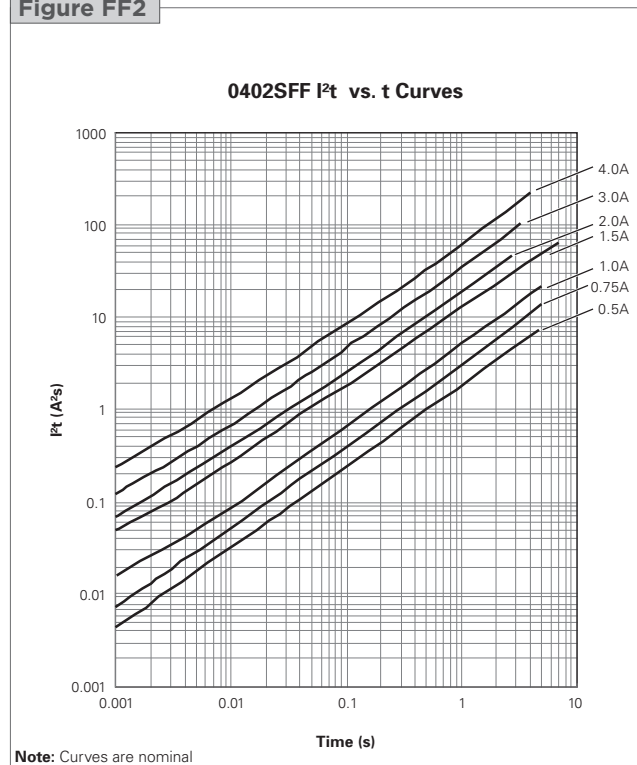
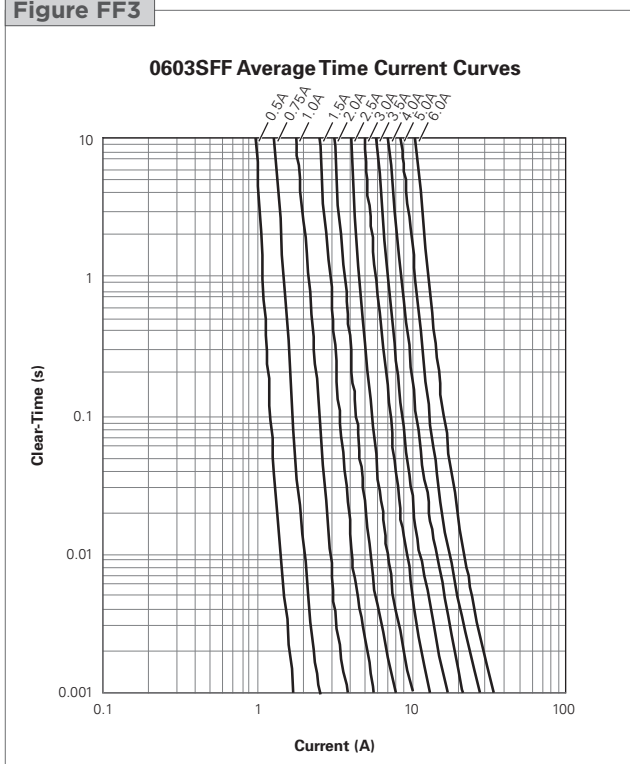
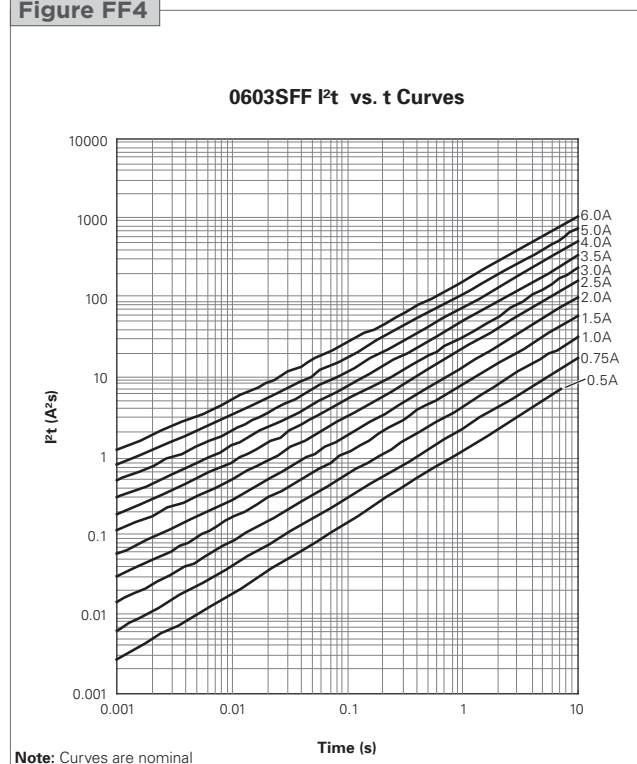
Figure FF1-FF6 Family Performance Curves for Fast-Acting Chip Fuses
Figure FF1

Figure FF2

Figure FF3

Figure FF4


Figure FF5

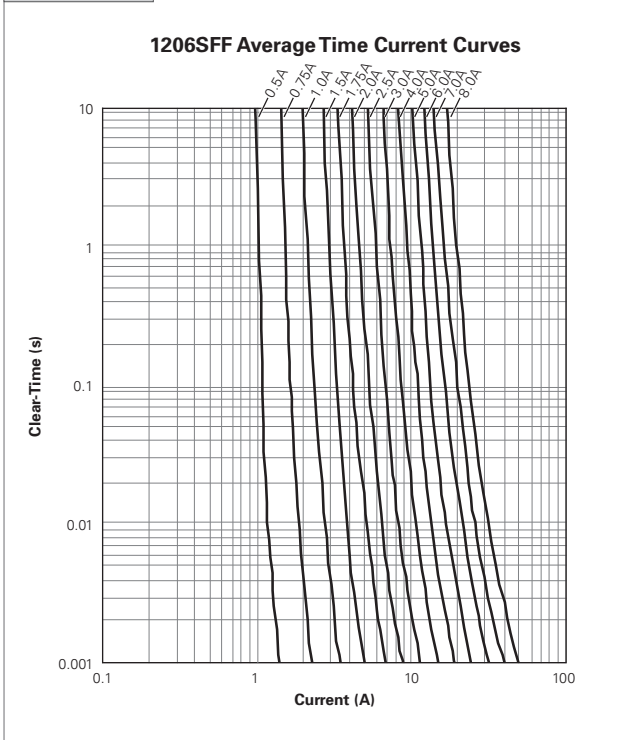
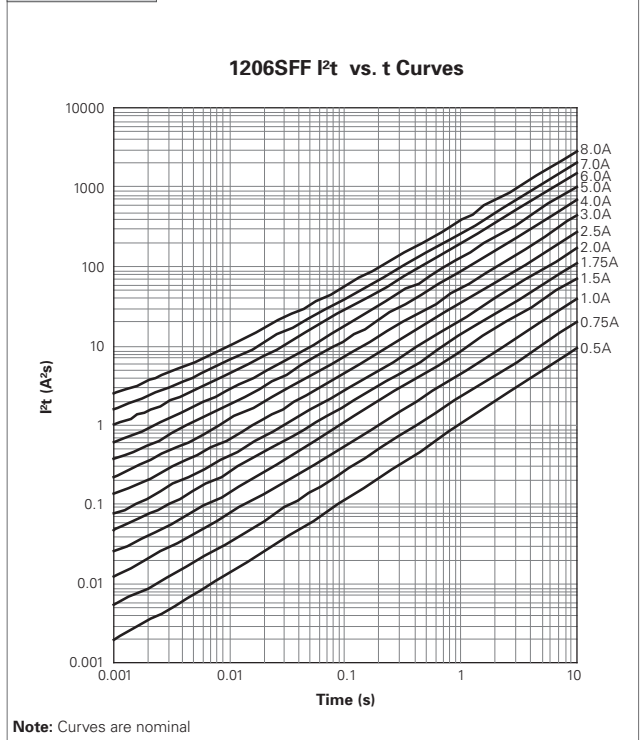


Figure FF6



→ Please go to page 97 for more information for Fast-Acting Chip Fuses.